ASSOCIATION CONNECTING LECTRANICS INDUSTRIES® INCLUSTRIES	PC. Bannockb	ourn. Illinois. A	Il rights reserved u ntions.	nder both	This docum level parts,	ent is a declaratio he declaration en	n of the substand compasses all lo	es within the manufactures within the manufactures wer level materials for w	rer listed it hich the m	em. Note: if anufacturer	the item is an as the engineering	sembly with lower responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information								
Supplier Information													
Company name* Compa			ompany unique ID			Unique ID Authority				Response Date*			
onsemi								2025-07-15					
ontact Name Title - Contact					Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro Co			o Compliance		NA			Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			entative		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	NCS2202	NCS2202SQ1T2G ANA COMPAR		ATORS		2025-07-15 MY1		MY1	1	3.43	mg	Each	
Manufacturing Proccess Informa	tion						-						
Terminal Plating / Grid Array Ma	Terminal Plating / Grid Array Material Terminal Base Alloy		Alloy J	J-STD-020 MSI	L Rating	Peak Proces	s Body Tempera	ture Max Time at Peak	Temperat	ure Numb	er of Reflow Cyc	eles	
Matte Tin (Sn) - annealed CU Alloy 1			1		260	С	30	secon	ds 3				
Comments													
evel 1 - maximum time at peak temperatu	ire during sol	dering is 10-3	0 seconds										
For more information regarding material	composition	please refer to	o page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

				ance category (JIG or Requester) or enter a [F] Optionally enter the positive (+) and n				
sigma range of distribution unless	,							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.67	mg	Supplier	Silicon (Si)	7440-21-3		0.67	mg
Die Attach Epoxy	0.15	mg		Epoxy resin	proprietary data		0.0975	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0525	mg
Lead Frame	2.35	mg	В	Nickel (Ni)	7440-02-0		0.853	mg
			Supplier	Iron (Fe)	7439-89-6		1.1797	mg
			Supplier	Copper (Cu)	7440-50-8		0.3172	mg
Lead Frame plating	0.05	mg	Supplier	Silver (Ag)	7440-22-4		0.05	mg
Mold Compound-Black	10.0	mg		Epoxy resin	proprietary data		0.5	mg
			Supplier	Phenolic Resin	Proprietary Data		0.5	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.2	mg
			Supplier	Carbon Black (C)	1333-86-4		0.05	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.75	mg
Plating	0.13	mg	Supplier	Tin (Sn)	7440-31-5		0.13	mg
Wire Bond - Au	0.08	mg	Supplier	Gold (Au)	7440-57-5		0.08	mg